



Multi-protocol Layer-Resilient Communication in Satellite–Terrestrial Integration Systems

Guest Editors:

Prof. Dr. Lidong Zhu

National Key laboratory of
Wireless Communication,
University of Electronic Science
and Technology of China,
Chengdu 611731, China

Prof. Dr. Minghua Xia

School of Electronics and
Information Technology, Sun Yat-
sen University, Guangzhou
510275, China

Prof. Dr. Mingchuan Yang

College of Information and
Communication Engineering,
Harbin Institute of Technology,
Harbin 150001, China

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Message from the Guest Editors

The integrated satellite–terrestrial system, which is based on terrestrial networks and extended by satellite networks to cover natural spaces, such as space, air, land, and ocean, is a necessary way to achieve ubiquitous connectivity in the 6G era. However, due to the periodic movement and open-channel nature of satellites, the instantaneous load on the satellite is not uniformly distributed, and communication signals are susceptible to interference signals. As a result, the overall load balancing and robustness of the network is seriously challenged, limiting further advancements in latency performance, network throughput, etc.

This Special Issue focuses on important technical areas, such as integrated satellite–terrestrial system architecture, standard specifications, resilient communications in physical, MAC, network layers, etc. Original research articles and reviews are welcome.

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Editor-in-Chief

Prof. Dr. Flavio Canavero

Department of Electronics and
Telecommunications,
Politecnico di Torino, 10129
Torino, Italy

Message from the Editor-in-Chief

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